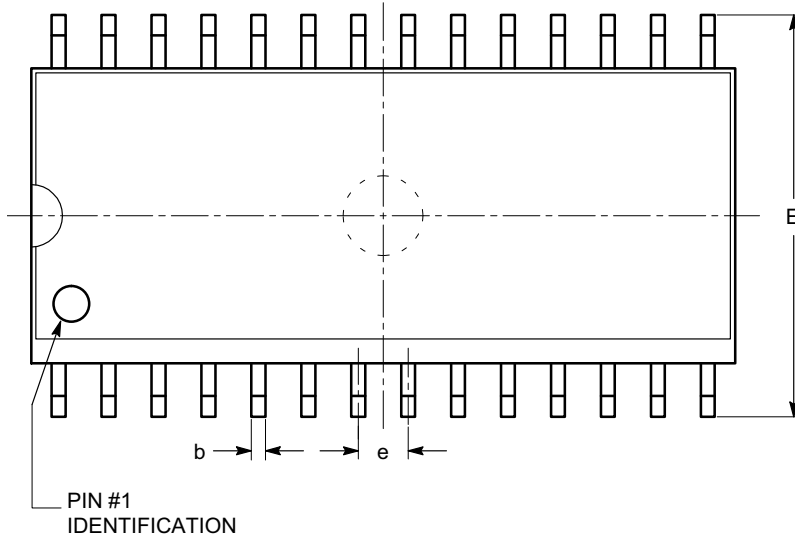


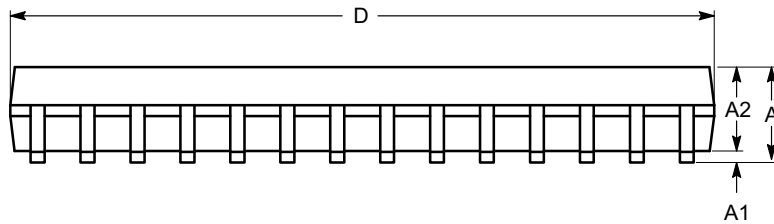
SOIC-28, 300 mils
CASE 751BM
ISSUE O

DATE 19 DEC 2008

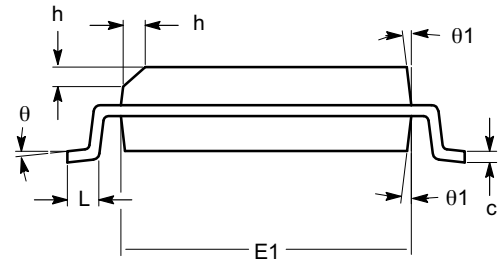


TOP VIEW

| SYMBOL | MIN | NOM | MAX |
|------------|----------|-----|-------|
| A | 2.35 | | 2.65 |
| A1 | 0.10 | | 0.30 |
| A2 | 2.05 | | 2.55 |
| b | 0.31 | | 0.51 |
| c | 0.20 | | 0.33 |
| D | 17.78 | | 18.03 |
| E | 10.11 | | 10.51 |
| E1 | 7.34 | | 7.60 |
| e | 1.27 BSC | | |
| h | 0.25 | | 0.75 |
| L | 0.40 | | 1.27 |
| θ | 0 | | 8 |
| θ_1 | 5 | | 15 |



SIDE VIEW



END VIEW

Notes:

- (1) All dimensions are in millimeters. Angles in degrees.
- (2) Complies with JEDEC MS-013.

| | | |
|------------------|-------------------|---|
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| DESCRIPTION: | SOIC-28, 300 MILS | PAGE 1 OF 1 |

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